



Opto-Link Options

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Acknowledgement
Ohio State/Oklahoma/Oklahoma State Universities

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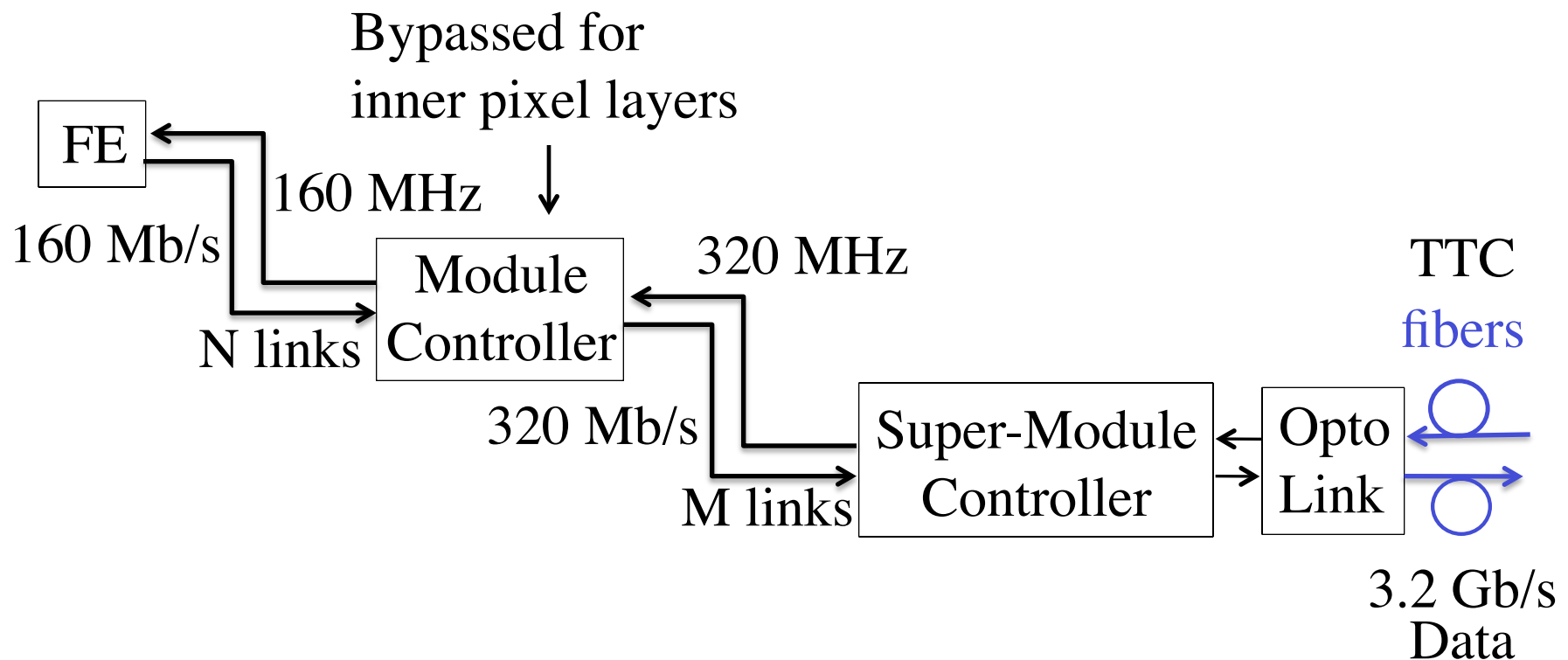
Outline

- Architecture
- PIN/VCSEL arrays
- Opto-pack
- Opto-chips
- Fibers
- Cables
- Summary



Read Out Architect

- G. Darbo, P. Farthouat, A. Grillo, ATL-P-EN-0001





SLHC Opto-Link Channel Count

R	staves	stave width	modules/ stave	$\frac{1}{2}$ stave rate	SMC/ stave	Links
cm		cm		Gb/s		
3.7	12	2	24	6.9	6	73
6	20	2	24	4.8	4	79
12	20	4	32	4.3	8	158
16	26	4	32	3.0	4	106
20	33	4	32	2.2	4	132

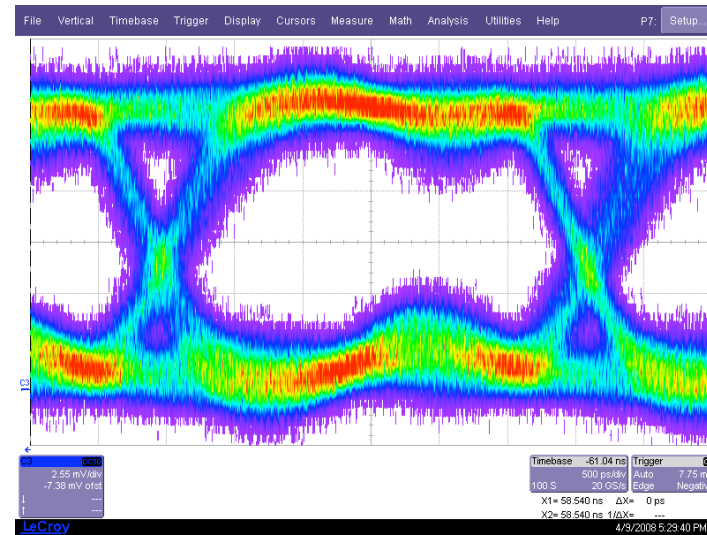
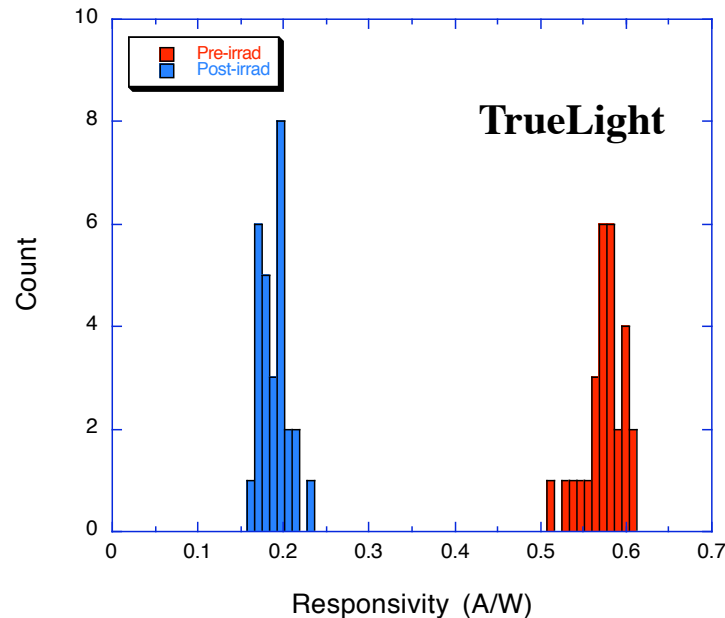
- Total number of SLHC barrel links: 548

■ current LHC barrel links: 1,458

- ⇒ number of links @ SLHC is manageable
- ⇒ no need to transmit at higher rate (> 3.2 Gb/s)



Radiation-Hardness of Silicon PIN

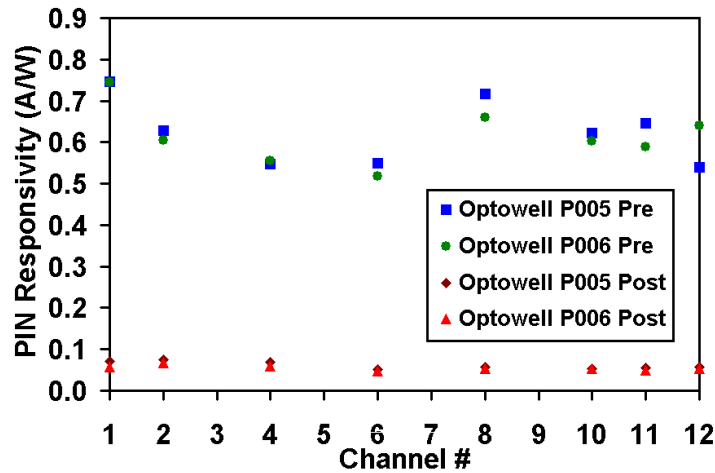
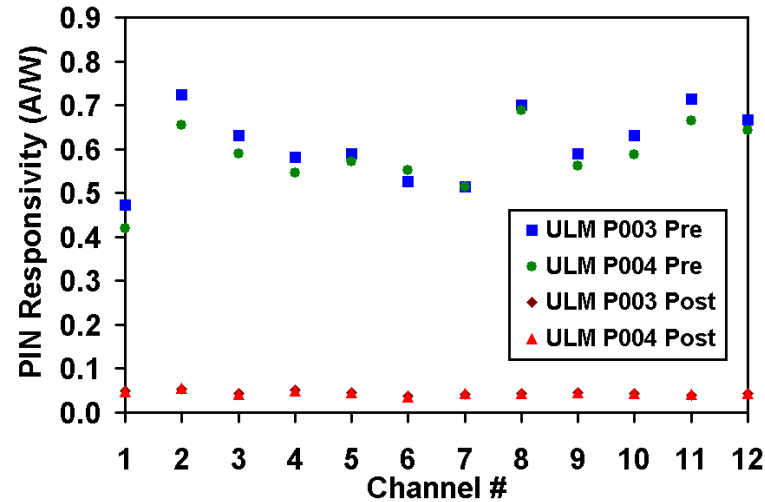
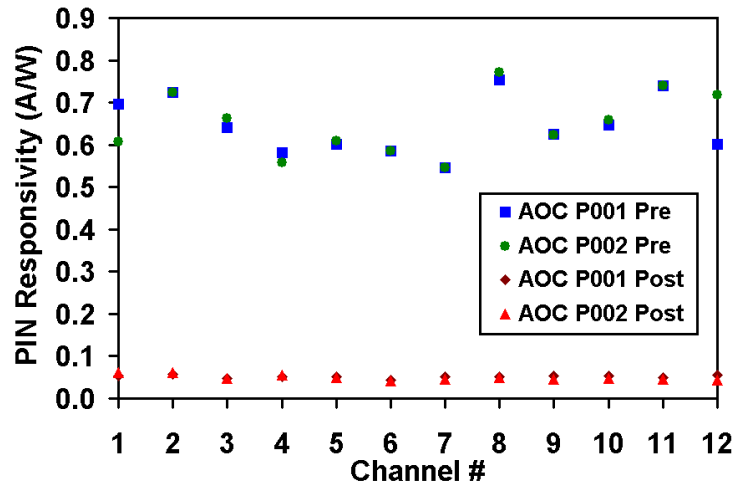


320 Mb/s (irradiated)

- irradiate PIN/VCSEL arrays with 24 GeV protons at CERN
- PIN responsivity decreases by 3x at 114 Mrad
 - ◆ SLHC at PP0: 69 Mrad or 1.5×10^{15} 1-MeV n_{eq}/cm^2 for $3,000^{-1}$ fb with 50% safety factor
- 320 Mb/s transmission is adequate



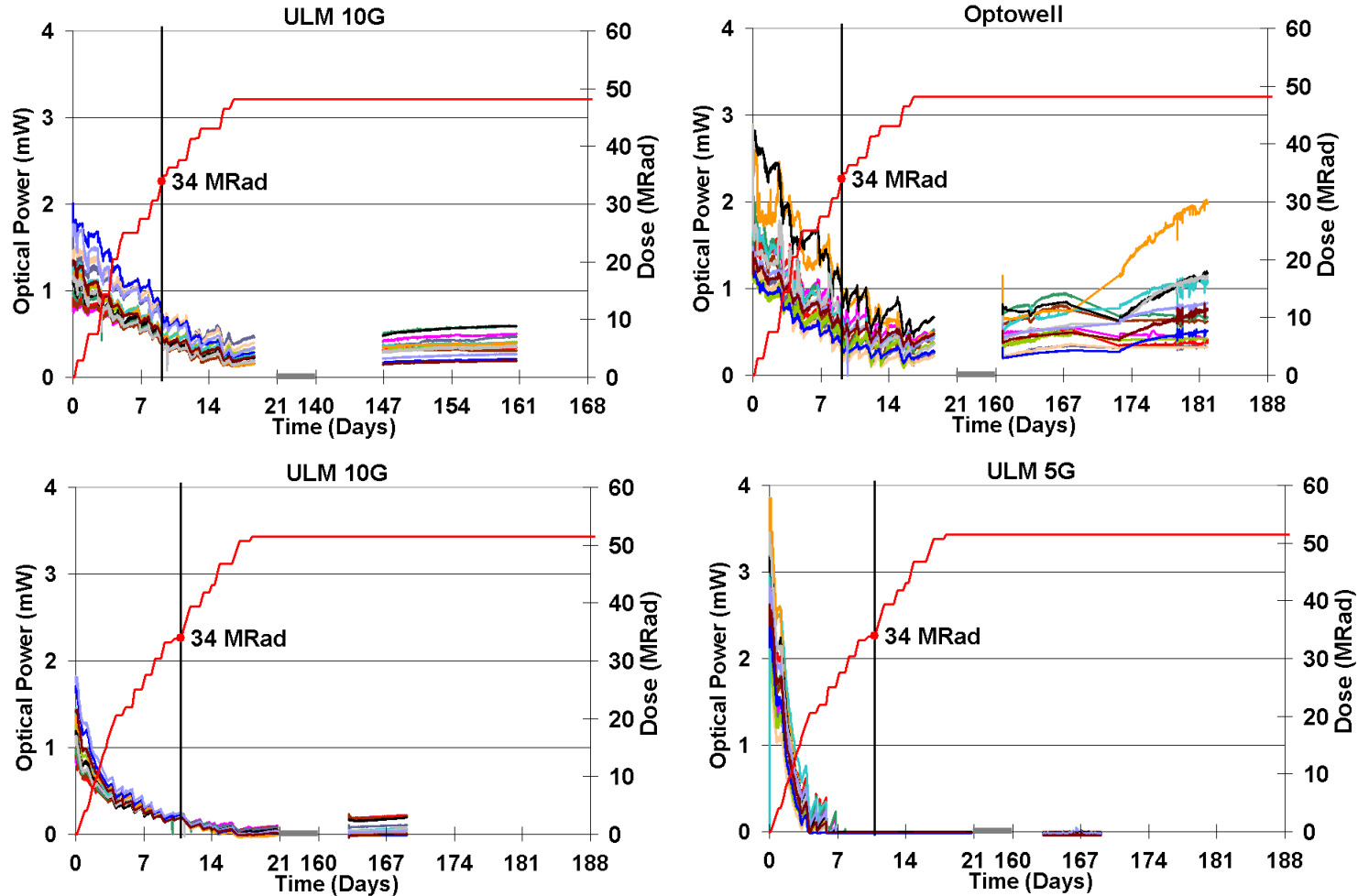
Radiation-Hardness of GaAs PIN



- all arrays are front side illuminated
- PIN responsivities decrease by ~10x at 53 Mrad
- should repeat irradiation to SLHC dosage of 34 Mrad (8.2×10^{15} 1-MeV n_{eq}/cm^2)



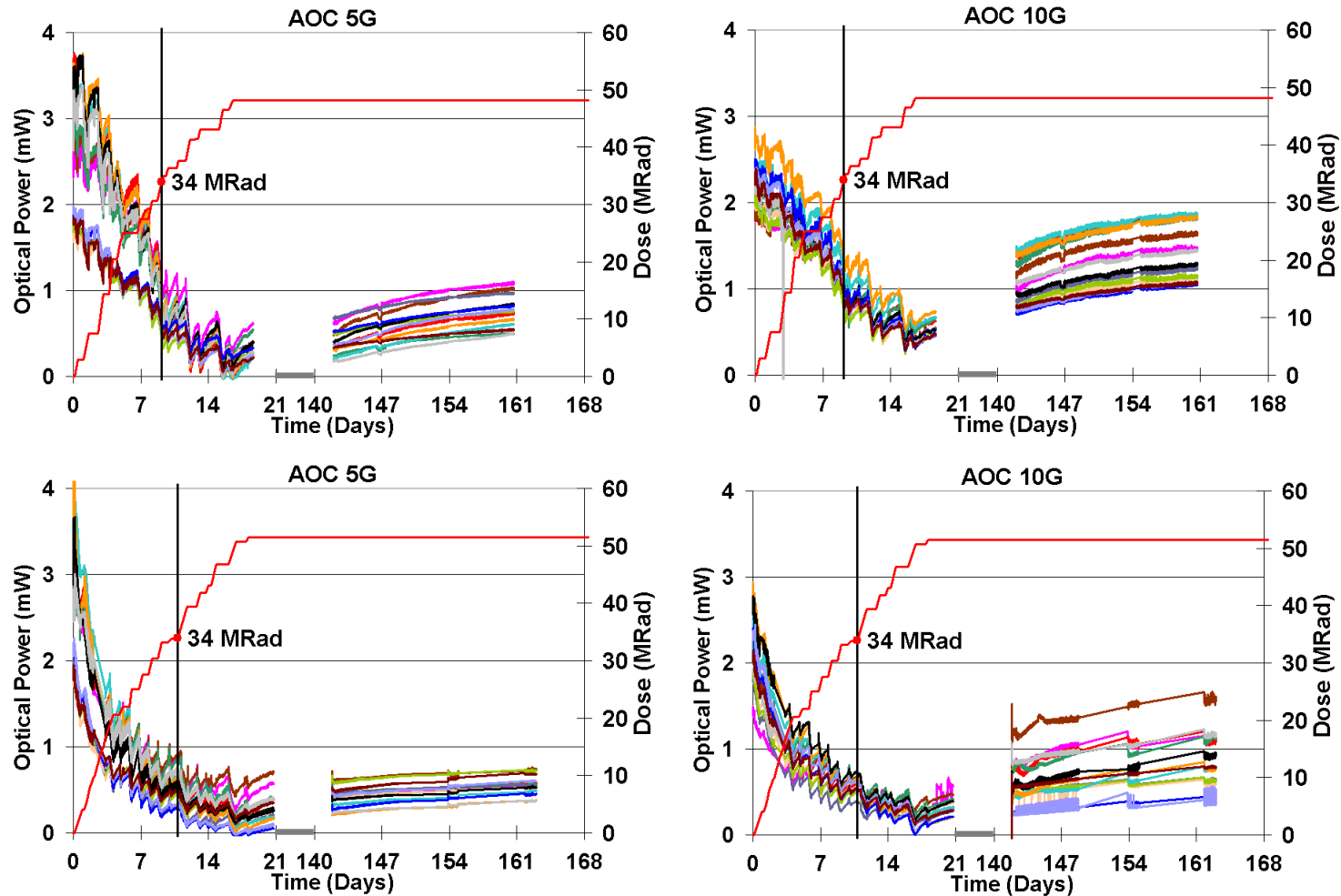
Annealing of VCSEL Arrays



- recovery is slow
- Optowell has the highest annealed power



Annealing of VCSEL Arrays

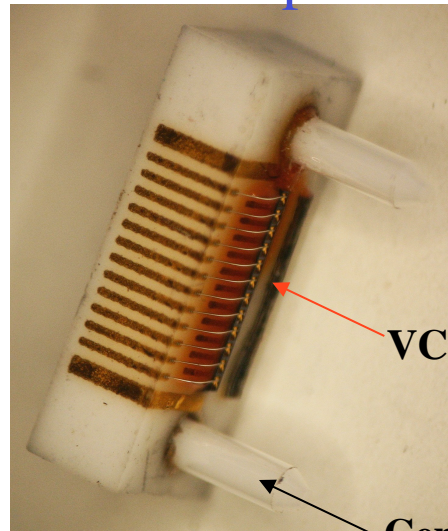
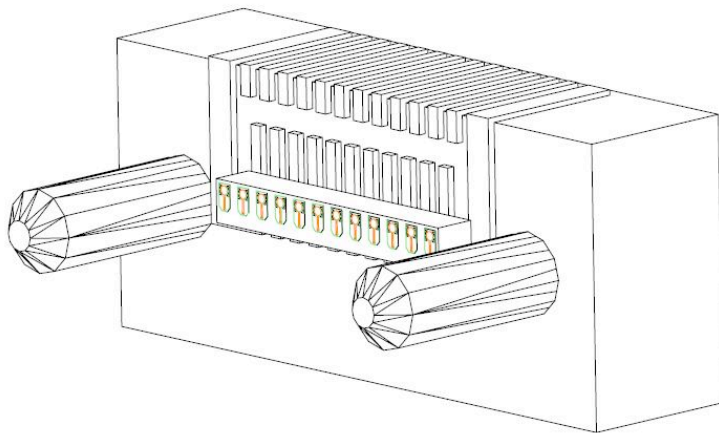


- recovery is slow but adequate annealed power



Opto-Pack

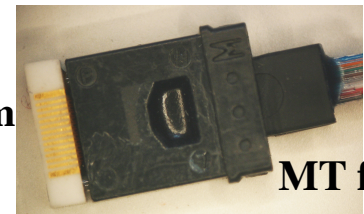
- current pixel detector uses Taiwan optical packages
 - ☹ VCSEL mounted on PCB with poor heat conduction
 - ☹ micro soldering of 250 μm leads is difficult
- Ohio State develops new opto-pack for SLHC
 - uses BeO base with 3D traces for efficient heat removal
 - wire bond to driver/receiver chip
 - new opto-packs have good coupled power
- next: modify MPO connector to replace current housing



1 cm

VCSEL array

Ceramic guide pin



MT ferrule



Versatile Link

- CERN's project to develop single-channel opto-link:
 - ◆ work with vendors to modify commercial opto-packs
 - ◆ evaluate radiation-hardness of opto components
 - ◆ institutions: CERN, Oxford, SMU
 - ◆ work on multiple-channel opto-links (arrays)
 - by pixel group complements their effort
 - ◆ in close collaboration with VL to take advantage of their R&D



Opto-Chips

- 4 mm² prototype chip:
 - ◆ PIN receiver/decoder operating at 40, 160 and 320 MHz
 - use bi-phase marked encoding due to the low speed
 - ◆ VCSEL drivers operating at 640 Mb/s and 3.2 Gb/s
 - ◆ both designs take advantage of LHC experience
 - ◆ SMC block: 640 MHz serialization clocks
 - SEU tolerant multipliers (16 x 40 MHz or 4 x 160 MHz)
 - ◆ extracted simulations show full functionality
- layout was reviewed at CERN on March 11, 08
- submitted to IBM via CERN to MOSIS on March 24, 08
- delivery date: July 08
- irradiation: August 08
 - ◆ study radiation-hardness and SEU



Opto-Chips

640 Mb/s VCSEL Driver

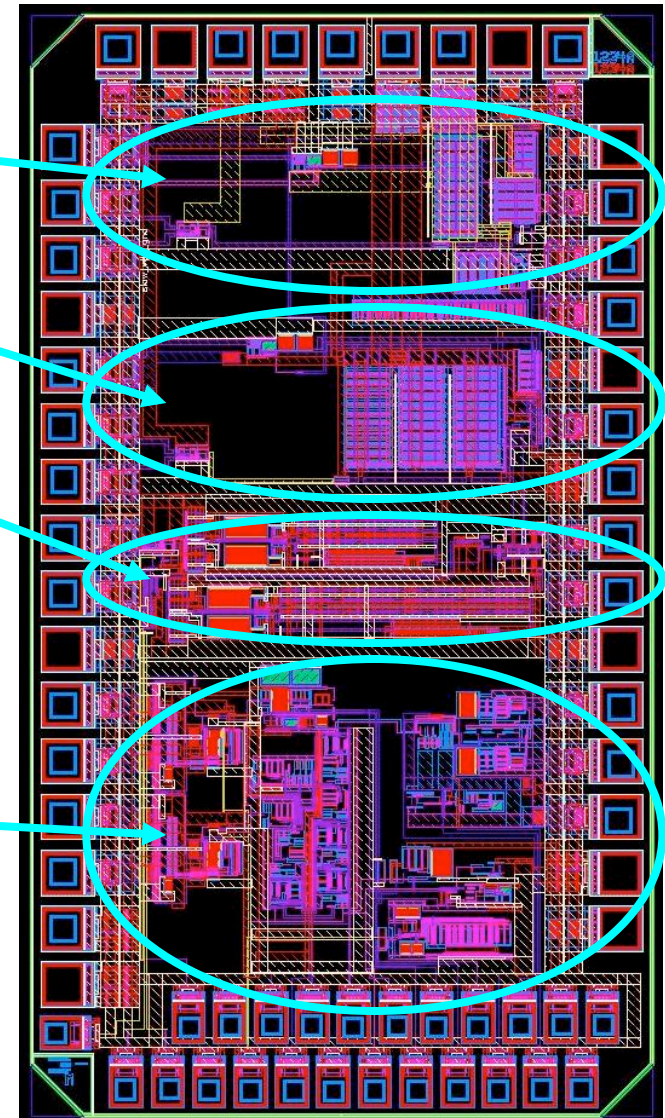
3.2 Gb/s VCSEL Driver

**640 MHz clock multipliers
(4 x and 16 x)**

PIN receiver/decoder

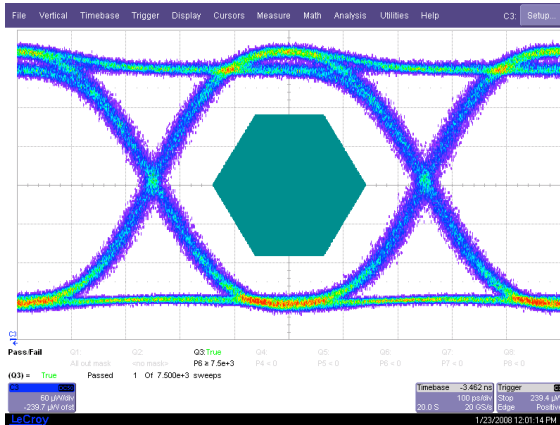
2.6 mm

1.5 mm

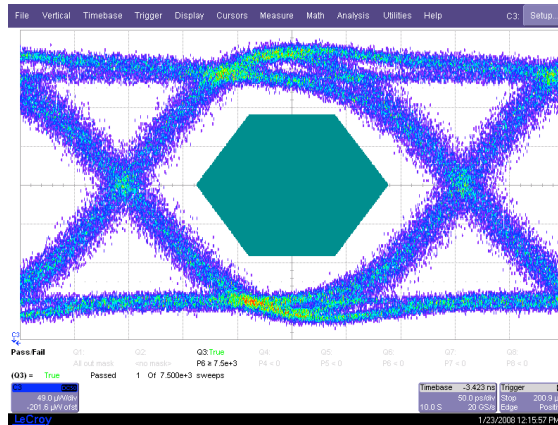




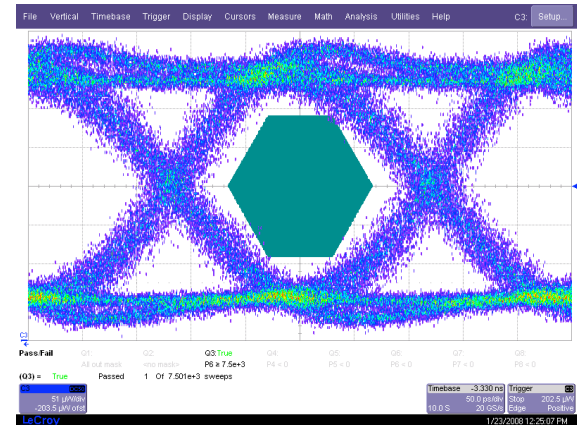
Bandwidth of Fiber



2 Gb/s



3.2 Gb/s



4.25 Gb/s

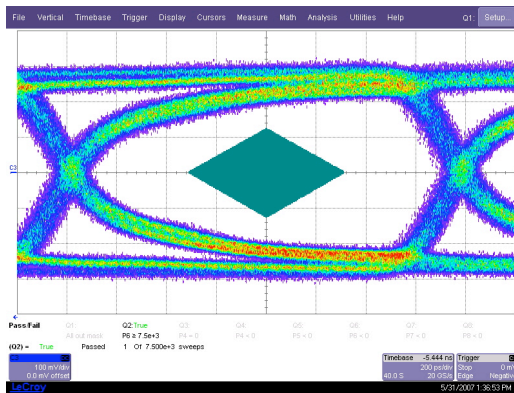
- current opto-link: 11 + 80 m spliced SIMM/GRIN fiber
 - transmission at 3.2 Gb/s is adequate
 - current SLHC architecture calls for raw rate of 3.2 Gb/s plus 20% overhead for 8b/10b encoding
 - ⇒ more efficient encoding will improve margin of operation
- new Corning fibers have higher bandwidth
 - will be irradiated by Oxford/SMU this summer



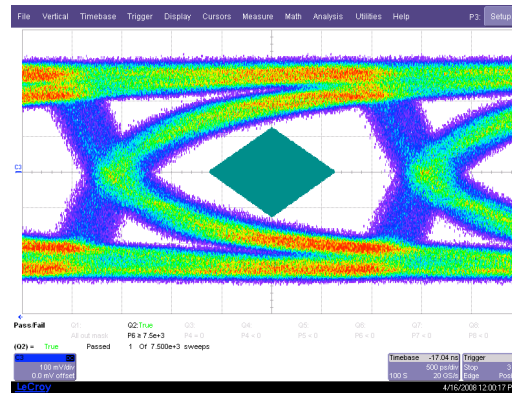
Eye Diagrams

100 μm current pixel cable

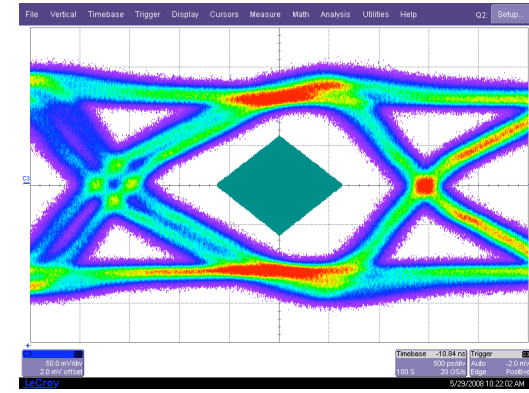
640 Mb/s
1.4 m



320 Mb/s
3 m



320 Mb/s
4 m



Pre-emphasis

- Signals from modules can be sent to current PP0 location (1.4 m)
- Signals from modules (320 Mb/s):
 - ◆ can be transmitted up to ~ 3 m

◆ can be transmitted up to ~ 4 m with pre-emphasis

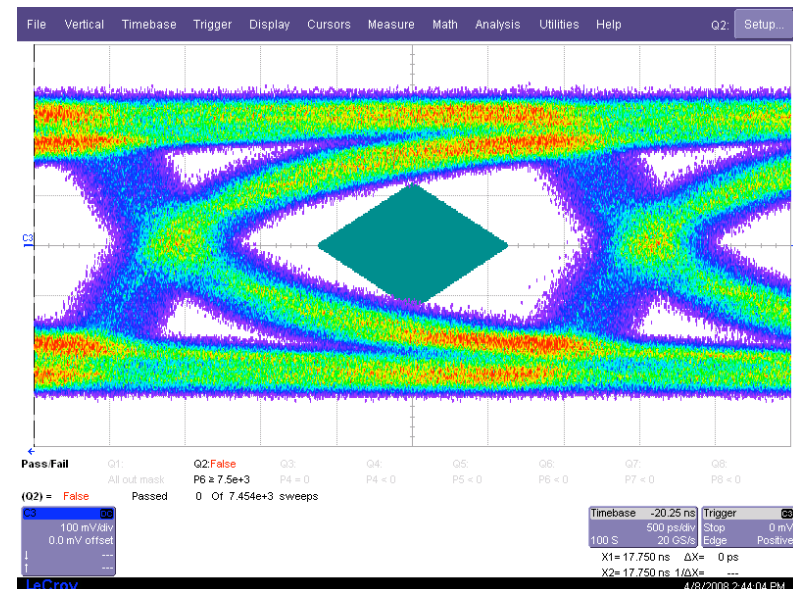
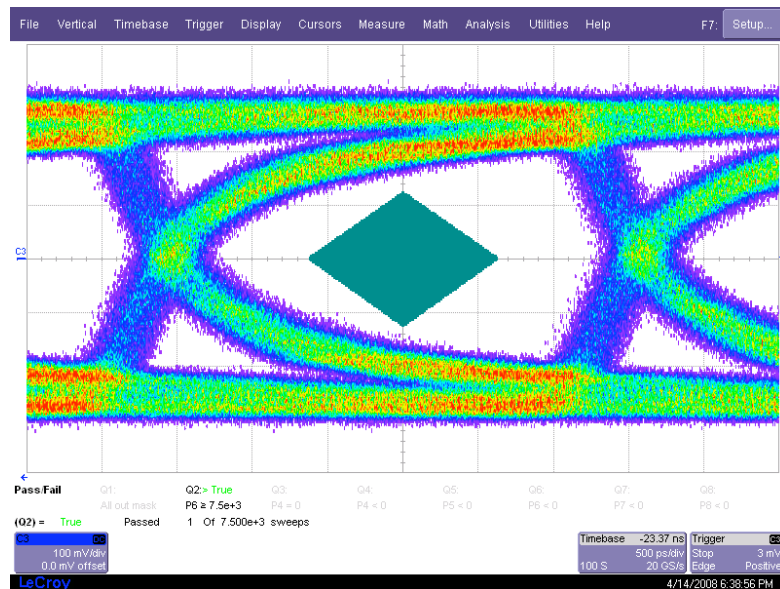


Eye Diagrams

1 mm TRT shield twisted pair (320 Mb/s, 100 Ω)

4 m

5 m

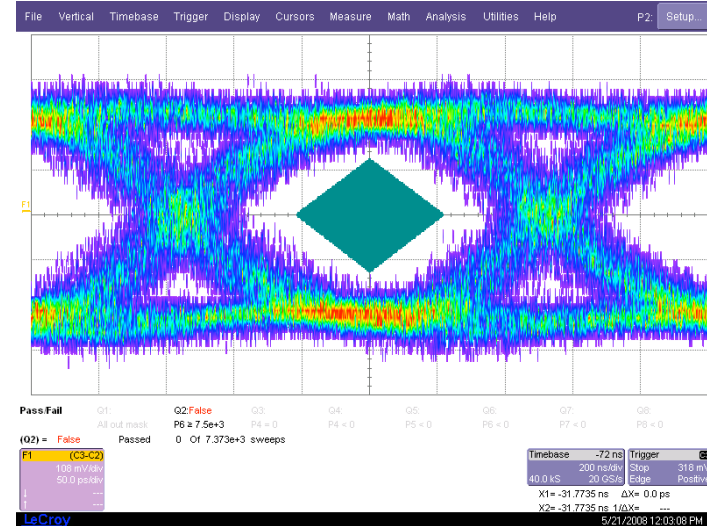
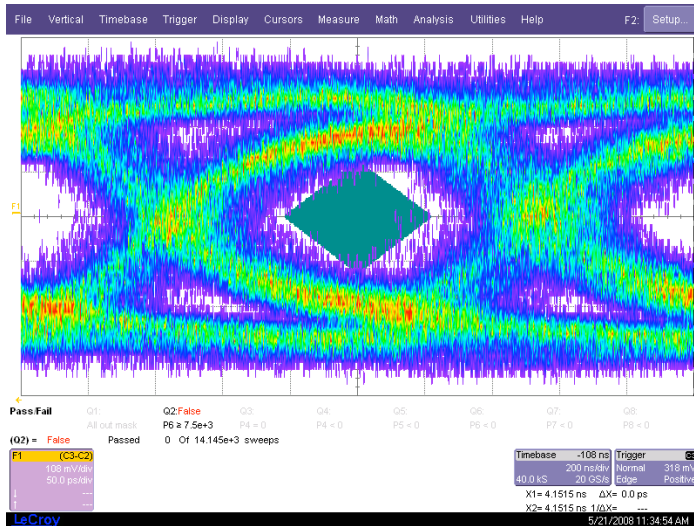


- Signals from modules (320 Mb/s) can be transmitted up to 4 m



Eye Diagrams

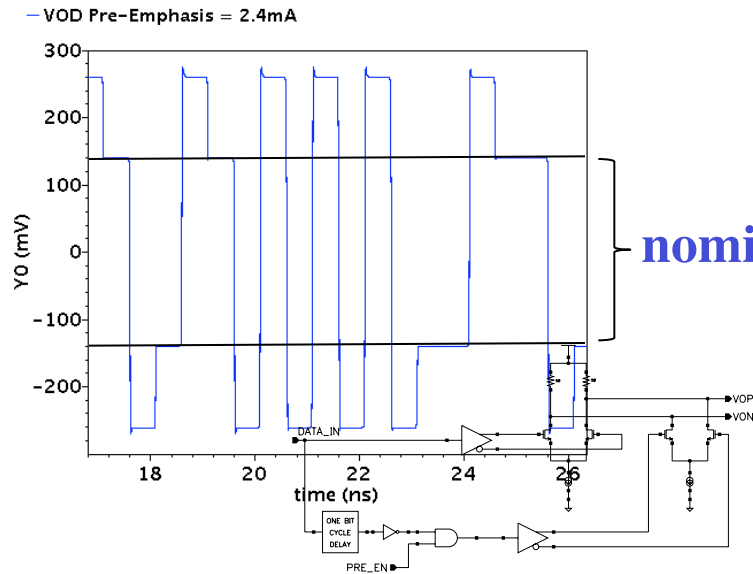
Pre-emphasis



- Use 4 m of Belden 1674A micro coax with 1.2 mm OD
 - ◆ transmit LVDS signals at 3.7 Gb/s on two coax
- Use Altera Stratix II GX to study pre-emphasis settings
 - ◆ use 8B/10B encoding
- pre-emphasis opens up the eye diagram

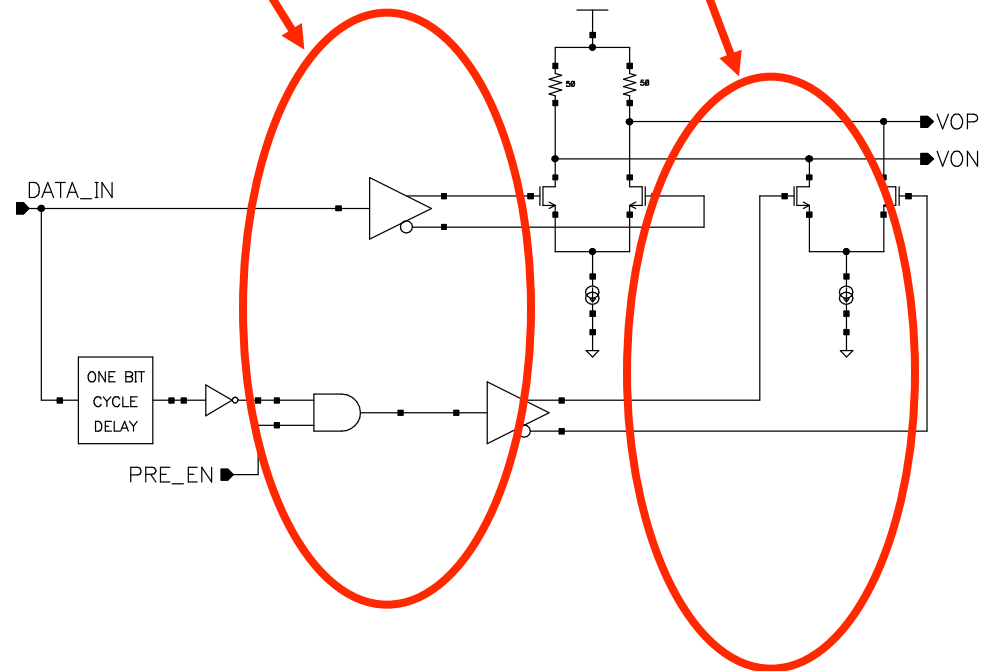


CMOS Driver with Pre-Emphasis



pre-emphasis tap supplies additional current as needed

set nominal drive current

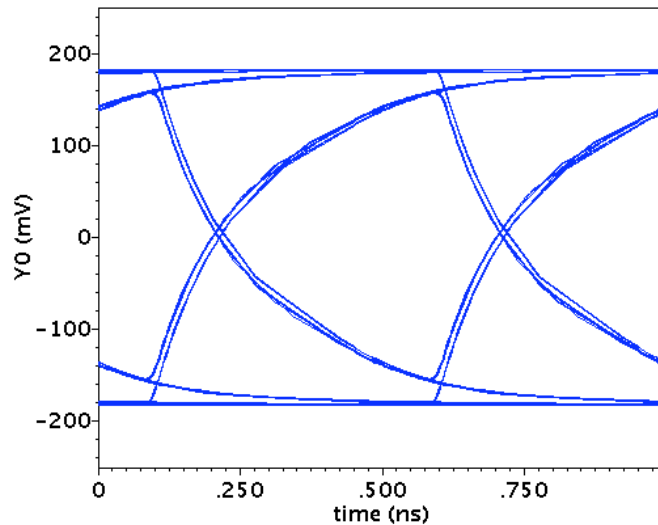


preliminary 130 nm design

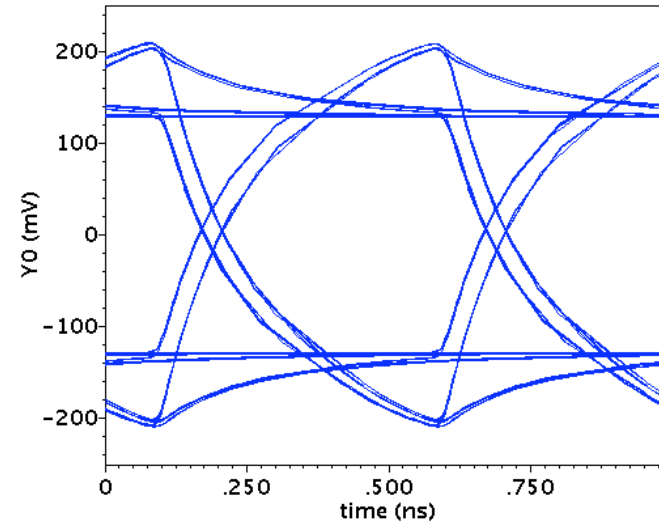


CMOS Driver Simulation

— No Pre-Emphasis



— 2.4mA Pre-Emphasis



Pre-emphasis

- Preliminary test with RC transmission line:
 - ◆ pre-emphasis opens the eye diagram



Opto-Link Locations

- Use skinny cables to transmit 320 Mb/s signal
 - ◆ no further R&D needed for 3 m transmission
 - ◆ modest R&D on pre-emphasis needed up for 4 m transmission
 - ◆ minimum material (8 x 2 x 150 μm (0.28 mm²) cables)
- Use TRT micro cables to transmit 320 Mb/s to 4 m
 - ◆ no further R&D needed
 - ◆ significantly more material (8 x 2 x 127 μm cables + insulation)
- Use micro coax to transmit 3.7 Gb/s to 4 m
 - ◆ significant R&D needed:
connector, cable material, ASIC, radiation-hardness, SEU
 - ◆ significantly more material (2 x 1.2 mm (2.3 mm²) cables)

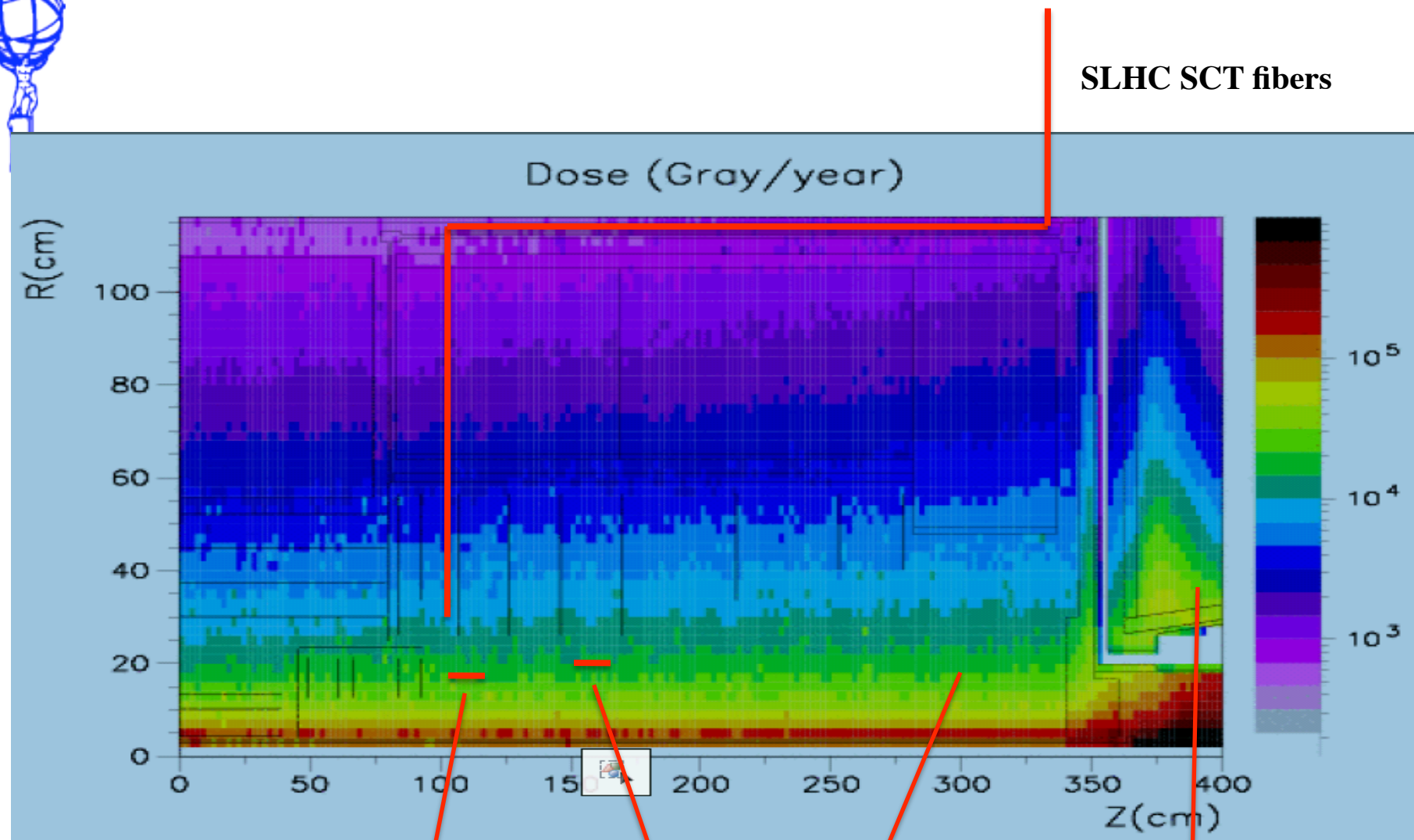


Figure 5.6 Annual doses (Gy/Year) assuming 10^7 s at high luminosity.

OSP bottom/ISP top

OSP top

•320 Mb/s on skinny cable
with pre-emphasis₂₀

•320 Mb/s on TRT cable

•3.7 Gb/s on coax cables

K.K. Gan

US ATLAS Pixel Upgrade Meeting

320 Mb/s on skinny cable



Summary

- Basic components satisfy the SLHC needs:
 - ◆ VCSEL/PIN, fibers, opto-pack
- proto-type chip will be evaluated in summer, including irradiation
- high-speed transmission in 4 m cable:
 - ◆ 320 Mb/s transmission on skinny wires minimize material and requires modest R&D
 - ◆ 3.2 Gb/s transmission on coax add significantly more material and requires significant R&D